MM54C90,MM54C93,MM74C90,MM74C93

MM54C90 MM74C90 4-Bit Decade Counter MM54C93 MM74C93 4-Bit Binary Counter

Literature Number: SNOS340A

National Semiconductor

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MM54C90/MM74C90 4-Bit Decade Counter
MM54C93/MM74C93 4-Bit Binary Counter

General Description

The MM54C90/MM74C90 decade counter and the MM54C93/MM74C93 binary counter and complementary MOS (CMOS) integrated circuits constructed with N- and P-channel enhancement mode transistors. The 4-bit decade counter can reset to zero or preset to nine by applying appropriate logic level on the R_{01}, R_{02}, R_{91} and R_{92} inputs. Also, a separate flip-flop on the A-bit enables the user to operate it as a divide-by-2, 5 or 10 frequency counter. The 4-bit binary counter can be reset to zero by applying high logic level on inputs R_{01} and R_{02}, and a separate flip-flop on the A-bit enables the user to operate it as a divide-by-2, -8, or -16 divider. Counting occurs on the negative going edge of the input pulse.

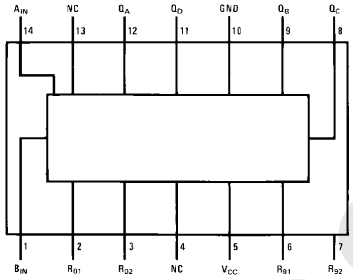
All inputs are protected against static discharge damage.

Features

- Wide supply voltage range — 3V to 15V
- Guaranteed noise margin — 1V
- High noise immunity — 0.45 V_{CC} (typ.)
- Low power — Fan out of 2
  TTL compatiblity — driving 74L
- The MM54C93/MM74C93 follows the MM54L93/MM74L93 Pinout

Connection and Logic Diagrams

MM54C90/MM74C90
Dual-In-Line Package



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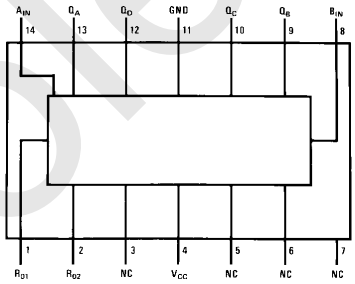
Top View

MM54C93/MM74C93
Dual-In-Line Package



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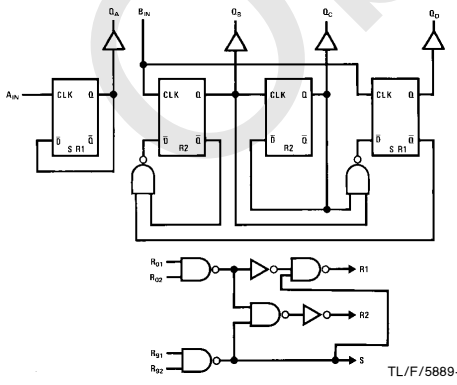
Top View

Order Number MM54C90 or MM74C93

M54C90/MM74C90



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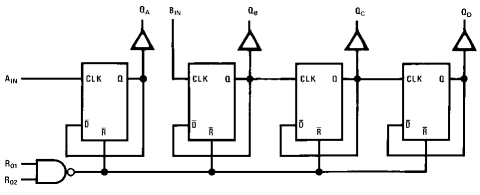
MM54C93/MM74C93



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RRD-B30M105/Printed in U. S. A.

Absolute Maximum Ratings

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Voltage at Any Pin (Note 1)	−0.3V to V_{CC} +0.3V
Operating Temperature Range (T_A)	
MM54C90, MM54C93	−55°C to +125°C
MM74C90, MM74C93	−40°C to +85°C
Power Dissipation (P_D)	
Dual-In-Line	700 mW
Small Outline	500 mW
Operating V_{CC} Range	3V to 15V
Absolute Maximum V_{CC}	18V
Storage Temperature Range (T_S)	−65°C to +150°C
Lead Temperature (T_L)	
(Soldering, 10 seconds)	260°C

DC Electrical Characteristics Min/Max limits apply across temperature range unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
CMOS TO CMOS						
$V_{IN(1)}$	Logical "1" Input Voltage	V_{CC} = 5V V_{CC} = 10V	3.5 8.0			V V
$V_{IN(0)}$	Logical "0" Input Voltage	V_{CC} = 5V V_{CC} = 10V			1.5 2.0	V V
$V_{OUT(1)}$	Logical "1" Output Voltage	V_{CC} = 5V, I_O = −10 μA V_{CC} = 10V, I_O = −10 μA	4.5 9.0			V V
$V_{OUT(0)}$	Logical "0" Output Voltage	V_{CC} = 5V, I_O = +10 μA V_{CC} = 10V, I_O = +10 μA			0.5 1.0	V V
$I_{IN(1)}$	Logical "1" Input Current	V_{CC} = 15V, V_{IN} = 15V		0.005	1.0	μA
$I_{IN(0)}$	Logical "0" Input Current	V_{CC} = 15V, V_{IN} = 0V	−1.0	−0.005		μA
I_{CC}	Supply Current	V_{CC} = 15V		0.05	300	μA
CMOS/LPTTL INTERFACE						
$V_{IN(1)}$	Logical "1" Input Voltage MM54C90, MM54C93 MM74C90, MM74C93	 V_{CC} = 4.5V V_{CC} = 4.75V	 V_{CC}−1.5 V_{CC}−1.5			 V V
$V_{IN(0)}$	Logical "0" Input Voltage MM54C90, MM54C93 MM74C90, MM74C93	 V_{CC} = 4.5V V_{CC} = 4.75V			 0.8 0.8	 V V
$V_{OUT(1)}$	Logical "1" Output Voltage MM54C90, MM54C93 MM74C90, MM74C93	 V_{CC} = 4.5V, I_O = −360 μA V_{CC} = 4.75V, I_O = −360 μA	 2.4 2.4			 V V
$V_{OUT(0)}$	Logical "0" Output Voltage MM54C90, MM54C93 MM74C90, MM74C93	 V_{CC} = 4.5V, I_O = −360 μA V_{CC} = 4.75V, I_O = −360 μA			 0.4 0.4	 V V
OUTPUT DRIVE (See 54C/74C Family Characteristics Data Sheet) (Short Circuit Current)						
I_{SOURCE}	Output Source Current (P-Channel)	V_{CC} = 5V, V_{OUT} = 0V T_A = 25°C	−1.75	−3.3		mA
I_{SOURCE}	Output Source Current (P-Channel)	V_{CC} = 10V, V_{OUT} = 0V T_A = 25°C	−8.0	−15		mA
I_{SINK}	Output Sink Current (N-Channel)	V_{CC} = 5V, V_{OUT} = V_{CC} T_A = 25°C	1.75	3.6		mA
I_{SINK}	Output Sink Current (N-Channel)	V_{CC} = 10V, V_{OUT} = V_{CC} T_A = 25°C	8.0	16		mA

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range", they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

AC Electrical Characteristics* T_A = 25°C, C_L = 50 pF, unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
t_{pd0}, t_{pd1}	Propagation Delay Time from A_{IN} to Q_A	V_{CC} = 5V V_{CC} = 10		200 80	400 150	ns ns
t_{pd0}, t_{pd1}	Propagation Delay Time from A_{IN} to Q_B (MM54C93/MM74C93)	V_{CC} = 5V V_{CC} = 10V		450 160	850 300	ns ns
t_{pd0}, t_{pd1}	Propagation Delay Time from A_{IN} to Q_B (MM54C90/MM74C90)	V_{CC} = 5V V_{CC} = 10V		450 160	800 300	ns ns

AC Electrical Characteristics* $T_A = 25°C$, $C_L = 50$ pF, unless otherwise specified (Continued)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
t_{pd0}, t_{pd1}	Propagation Delay Time from A_{IN} to Q_C (MM54C93/MM74C93)	$V_{CC} = 5V$ $V_{CC} = 10$		500 200	1050 400	ns ns
t_{pd0}, t_{pd1}	Propagation Delay Time from A_{IN} to Q_C (MM54C93/MM74C93)	$V_{CC} = 5V$ $V_{CC} = 10V$		500 200	1000 400	ns ns
t_{pd0}, t_{pd1}	Propagation Delay Time from A_{IN} to Q_D (MM54C93/MM74C93)	$V_{CC} = 5V$ $V_{CC} = 10V$		600 250	1200 500	ns ns
t_{pd0}, t_{pd1}	Propagation Delay Time from A_{IN} to Q_D (MM54C90/MM74C90)	$V_{CC} = 5V$ $V_{CC} = 10V$		450 160	800 300	ns ns
t_{pd0}, t_{pd1}	Propagation Delay Time from R_{01} or R_{02} to Q_A, Q_B, Q_C or Q_D (MM54C93/MM74C93)	$V_{CC} = 5V$ $V_{CC} = 10V$		150 75	300 150	ns ns
t_{pd0}, t_{pd1}	Propagation Delay Time from R_{01} or R_{02} to Q_A, Q_B, Q_C or Q_D (MM54C90/MM74C90)	$V_{CC} = 5V$ $V_{CC} = 10V$		200 75	400 150	ns ns
t_{pd0}, t_{pd1}	Propagation Delay Time from R_{91} or R_{92} to Q_A or Q_D (MM54C90/MM74C90)	$V_{CC} = 5V$ $V_{CC} = 10V$		250 100	500 200	ns ns
t_{PW}	Min. R_{01} or R_{02} Pulse Width (MM54C93/MM74C93)	$V_{CC} = 5V$ $V_{CC} = 10V$	600 30	250 125		ns ns
t_{PW}	Min. R_{01} or R_{02} Pulse Width (MM54C90/MM74C90)	$V_{CC} = 5V$ $V_{CC} = 10V$	600 300	250 125		ns ns
t_{PW}	Min. R_{91} or R_{92} Pulse Width (MM54C90/MM74C90)	$V_{CC} = 5V$ $V_{CC} = 10V$	500 250	200 100		ns ns
t_r, t_f	Maximum Clock Rise and Fall Time	$V_{CC} = 10V$ $V_{CC} = 10V$			15 5	μs μs
t_W	Minimum Clock Pulse Width	$V_{CC} = 5V$ $V_{CC} = 10V$	250 100	100 50		ns ns
f_{MAX}	Maximum Clock Frequency	$V_{CC} = 5V$ $V_{CC} = 10V$	2 5			MHz MHz
C_{IN}	Input Capacitance	Any Input (Note 2)		5		pF
C_{PD}	Power Dissipation Capacitance	Per Package (Note 3)		45		pF

*AC Parameters are guaranteed by DC correlated testing.

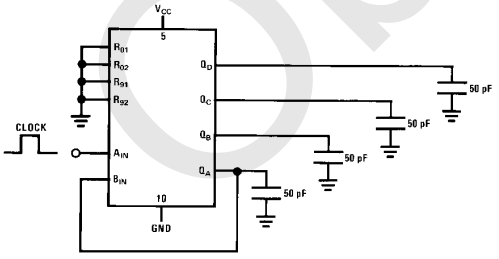
Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range", they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: Capacitance is guaranteed by periodic testing.

Note 3: C_{PD} determines the no load ac power consumption of any CMOS device. For complete explanation see 54C/74C Family Characteristics application note—AN-90.

AC Test Circuits

MM54C90/MM74C90



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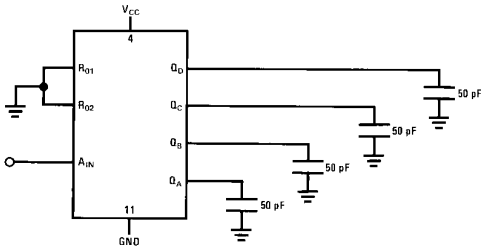
Clock rise and fall time $t_r = t_f = 20$ ns

MM54C93/MM74C93



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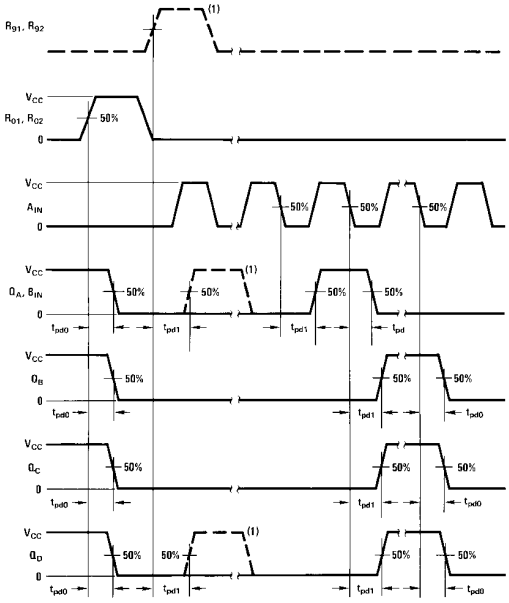
Clock rise and fall time $t_r = t_f = 20$ ns

Switching Time Waveforms



Note 1: MM54C90, MM74C90 and MM54C93, MM74C93 are solid line waveforms. Dashed line waveforms are for MM54C90/MM74C90 only.

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Truth Table

MM54C90/MM74C90 4-Bit Decade Counter

BCD Count Sequence

Count	Output			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H

Output Q_A is connected to Input B for BCD count.

H = High Level
L = Low Level
X = Irrelevant

Reset/Count Function Table

Reset Inputs				Output			
R_{01}	R_{02}	R_{91}	R_{92}	Q_D	Q_C	Q_B	Q_A
H	H	L	X	L	L	L	L
H	H	X	L	L	L	L	L
X	X	H	H	H	L	L	H
X	L	X	L	Count			
L	X	L	X	Count			
L	X	X	L	Count			
X	L	L	X	Count			

MM54C93/MM74C93 4-Bit Binary Counter

Binary Count Sequence

Count	Output			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H
10	H	L	H	L
11	H	L	H	H
12	H	H	L	L
13	H	H	L	H
14	H	H	H	L
15	H	H	H	H

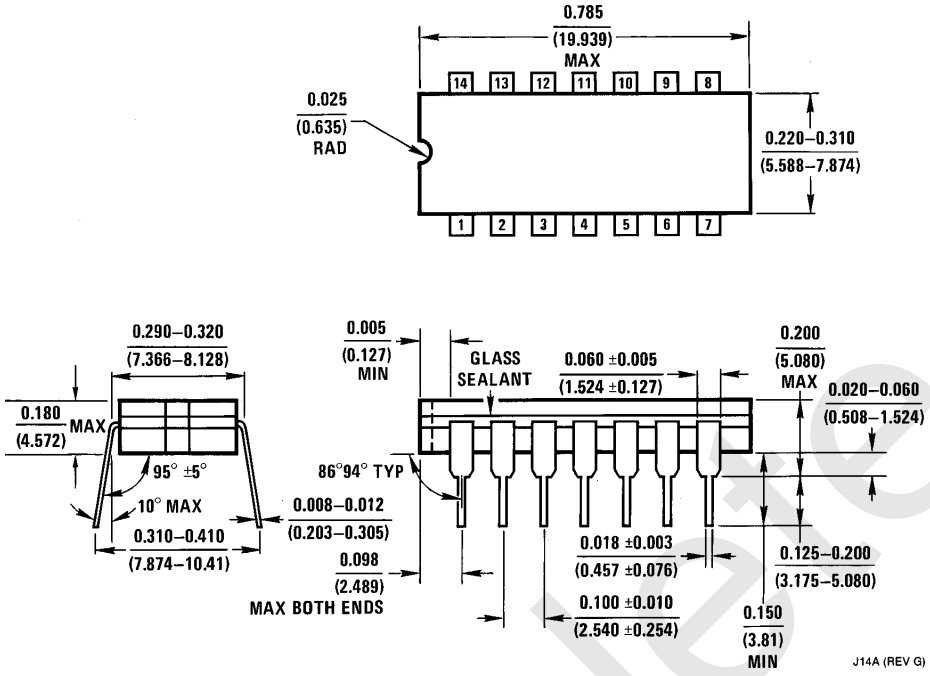
Output Q_A is connected to input B for binary count sequence.

H = High Level
L = Low Level
X = Irrelevant

Reset/Count Function Table

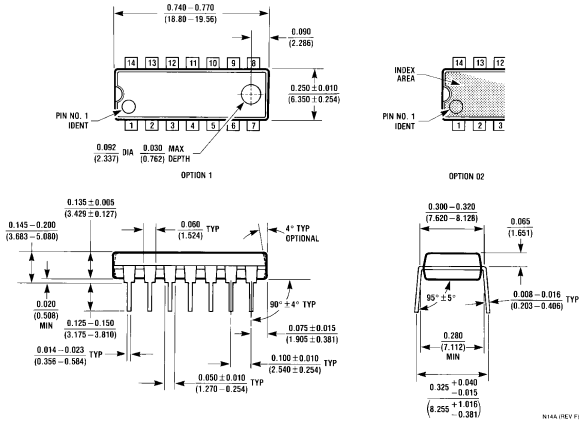
Reset Inputs		Output			
R_{01}	R_{02}	Q_D	Q_C	Q_B	Q_A
H	H	L	L	L	L
L	X	Count			
X	L	Count			

Physical Dimensions inches (millimeters)



Ceramic Dual-In-Line Package (J)
Order Number MM54C90J, MM54C93J, MM74C90J or MM74C93J
NS Package Number J14A

Physical Dimensions inches (millimeters) (Continued)



Molded Dual-In-Line Package (N)
Order Number MM54C90N, MM54C93N, MM74C90N or MM74C93N
NS Package Number N14A

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